

January 1995 Revised January 1999

74ABT16501

18-Bit Universal Bus Transceivers with 3-STATE Outputs

General Description

The ABT16501 18-bit universal bus transceiver combines D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in each direction is controlled by output-enable (OEAB and OEBĀ), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is HIGH. When LEAB is LOW, the A data is latched if CLKAB is held at a HIGH or LOW logic level. If LEAB is LOW, the A bus data is stored in the latch/flip-flop on the LOW-to-HIGH transition of CLKAB. Output-enable OEAB is active-high. When OEAB is HIGH, the outputs are active. When OEAB is LOW, the outputs are in the high-impedance state.

 plementary (OEAB is active HIGH and OEBA is active LOW)

To ensure the high-impedance state during power up or power down, OE inputs should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

Features

- Combines D-Type latches and D-Type flip-flops for operation in transparent, latched, or clocked mode
- Flow-through architecture optimizes PCB layout
- Guaranteed latch-up protection
- High impedance glitch free bus loading during entire power up and power down cycle
- Non-destructive hot insertion capability

Ordering Code:

Order Number Package Number			Package Description
	74ABT16501CSSC	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
	74ABT16501CMTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Devices also available in Tape or Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Pin Assignment for SSOP



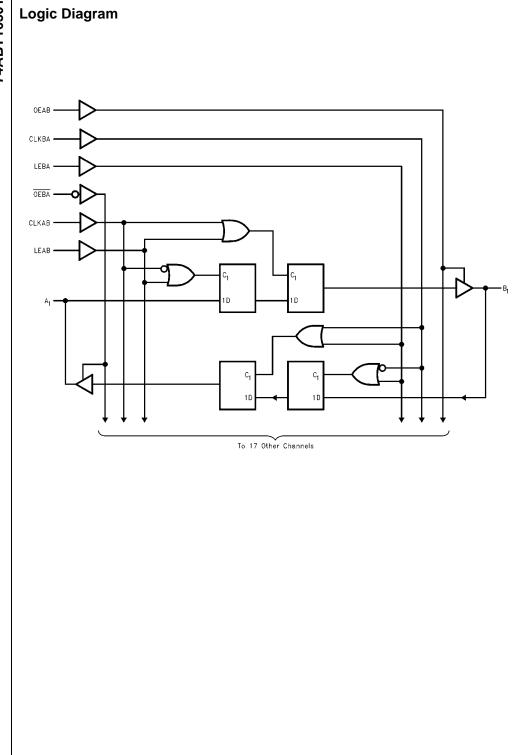
Function Table (Note 1)

	Output			
OEAB	LEAB	CLKAB	Α	В
L	Х	Х	Х	Z
Н	Н	Χ	L	L
Н	Н	Χ	Н	Н
Н	L	\uparrow	L	L
Н	L	\uparrow	Н	Н
Н	L	Н	X	B ₀ (Note 2)
Н	L	L	X	B ₀ (Note 3)

Note 1: A-to-B data flow is shown: B-to-A flow is similar but uses $\overline{\text{OEBA}}$, LEBA, and CLKBA

Note 2: Output level before the indicated steady-state input conditions were established.

Note 3: Output level before the indicated steady-state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW.



Absolute Maximum Ratings(Note 4)

 $\begin{array}{lll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to } +125^{\circ}\mbox{C} \\ \mbox{Junction Temperature under Bias} & -55^{\circ}\mbox{C to } +150^{\circ}\mbox{C} \\ \end{array}$

V_{CC} Pin Potential to

 $\begin{array}{lll} \mbox{Ground Pin} & -0.5\mbox{V to } +7.0\mbox{V} \\ \mbox{Input Voltage (Note 5)} & -0.5\mbox{V to } +7.0\mbox{V} \\ \mbox{Input Current (Note 5)} & -30\mbox{ mA to } +5.0\mbox{ mA} \\ \end{array}$

Voltage Applied to Any Output in the Disabled or

Power-off State -0.5V to 5.5V in the HIGH State -0.5V to V_{CC}

Current Applied to Output

in LOW State (Max) $\qquad \qquad \text{twice the rated I}_{\text{OL}} \, (\text{mA})$

DC Latchup Source Current -500 mA
Over Voltage Latchup (I/O) 10V

Recommended Operating Conditions

Free Air Ambient Temperature -40°C to $+85^{\circ}\text{C}$ Supply Voltage +4.5V to +5.5V

Minimum Input Edge Rate (ΔV/Δt)

Data Input 50 mV/ns
Enable Input 20 mV/ns

Note 4: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 5: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	Min	Тур	Max	Units	V _{CC}	Conditions
V _{IH}	Input HIGH Voltage	2.0			V		Recognized HIGH Signal
V _{IL}	Input LOW Voltage			8.0	V		Recognized LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	2.5			V	Min	I _{OH} = -3 mA
		2.0			V	Min	I _{OH} = -32 mA
V _{OL}	Output LOW Voltage			0.55	V	Min	I _{OL} = 64 mA
I _{IH}	Input HIGH Current			1	μΑ	Max	V _{IN} = 2.7V (Note 6)
				1			$V_{IN} = V_{CC}$
I _{BVI}	Input HIGH Current Breakdown Test			7	μΑ	Max	V _{IN} = 7.0V
I _{IL}	Input LOW Current			-1	μΑ	Max	V _{IN} = 0.5V (Note 6)
				-1			$V_{IN} = 0.0V$
V _{ID}	Input Leakage Test	4.75			V	0.0	$I_{ID} = 1.9 \mu\text{A}$
							All Other Pins Grounded
I _{IH} +	Output Leakage Current			10	μА	0 – 5.5V	$V_{OUT} = 2.7V; \overline{OE}, OE = 2.0V$
l _{OZH}							
I _{IL} +	Output Leakage Current			-10	μΑ	0 – 5.5V	$V_{OUT} = 0.5V; \overline{OE}, OE = 2.0V$
I _{OZL}							
Ios	Output Short-Circuit Current	-100		-275	mA	Max	V _{OUT} = 0V
I _{CEX}	Output HIGH Leakage Current			50	μΑ	Max	$V_{OUT} = V_{CC}$
I_{ZZ}	Bus Drainage Test			100	μΑ	0.0	V _{OUT} = 5.5V; All Others GND
I _{CCH}	Power Supply Current			1.0	mA	Max	All Outputs HIGH
I _{CCL}	Power Supply Current			68	mA	Max	An or Bn Outputs LOW
I _{CCZ}	Power Supply Current			1.0	mA	Max	$\overline{OE}_n = V_{CC}$
							All Others at V _{CC} or GND
I _{CCT}	Additional I _{CC} /Input			2.5	mA	Max	$V_I = V_{CC} - 2.1V$
							All Others at V _{CC} or GND
I _{CCD}	Dynamic I _{CC} No Load				mA/	Max	Outputs Open
	(Note 6)			0.23	MHz		Transparent Mode
		1					One Bit Toggling, 50% Duty Cycle

Note 6: Guaranteed, but not tested.

DC Electrical Characteristics

Symbol	Parameter	Min	Тур	Max	Units	v _{cc}	Conditions $C_L = 50 \text{ pF}; R_L = 500\Omega$
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}		0.7	1.2	V	5.0	T _A = 25°C (Note 7)
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	-1.5	-1.0		V	5.0	T _A = 25°C (Note 7)
V _{OHV}	Minimum HIGH Level Dynamic Output Voltage	2.5	3.0		V	5.0	T _A = 25°C (Note 8)
V _{IHD}	Minimum HIGH Level Dynamic Input Voltage	2.2	1.8		V	5.0	T _A = 25°C (Note 9)
V _{ILD}	Maximum LOW Level Dynamic Input Voltage		1.2	0.8	V	5.0	T _A = 25°C (Note 9)

Note 7: Max number of outputs defined as (n). n - 1 data inputs are driven 0V to 3V. One output at LOW. Guaranteed, but not tested

Note 8: Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output HIGH. Guaranteed, but not tested.

Note 9: Max number of data inputs (n) switching. n – 1 inputs switching 0V to 3V. Input-under-test switching: 3V to threshold (V_{ILD}), 0V to threshold (V_{IHD}).

AC Electrical Characteristics

Symbol	Parameter		$T_A = +25$ °C $V_{CC} = +5V$ $C_L = 50 \text{ pF}$			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $V_{CC} = 4.5\text{V} - 5.5\text{V}$ $C_L = 50 \text{ pF}$	
		Min	Тур	Max	Min	Max	
f _{max}	Maximum Clock Frequency	150	200		150		MHz
t _{PLH}	Propagation Delay	1.0	2.7	4.6	1.0	4.6	ns
t _{PHL}	A or B to B or A	1.0	3.2	4.6	1.0	4.6	
t _{PLH}	Propagation Delay	1.0	3.1	5.0	1.0	5.0	ns
t _{PHL}	LEAB or LEBA to B or A	1.0	3.6	5.5	1.0	5.5	
t _{PLH}	Propagation Delay	1.0	3.4	5.3	1.0	5.3	ns
t _{PHL}	CLKAB or CLKBA to B or A	1.0	3.7	5.3	1.0	5.3	
t _{PZH}	Propagation Delay	1.5	2.7	5.6	1.5	5.6	ns
t _{PZL}	OEAB or OEBA to B or A	1.5	3.0	5.6	1.5	5.6	
t _{PHZ}	Propagation Delay	1.5	3.7	6.0	1.5	6.0	ns
t _{PLZ}	OEAB or OEBA to B or A	1.5	3.2	6.0	1.5	6.0	

AC Operating Requirements

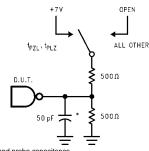
		$T_A =$	+25°C	T _A = -40°	C to +85°C	
Symbol	Parameter	$V_{CC} = +5V$ $C_L = 50 \text{ pF}$		V _{CC} = 4.5V–5.5V C _L = 50 pF		Units
Symbol	i arameter					
		Min	Max	Min	Max	
t _S (H)	Setup Time,	4.0		4.0		ns
t _S (L)	A to CLKAB, B to CLKBA	4.0		4.0		
t _H (H)	Hold Time,	0		0		ns
t _H (L)	A to CLKAB, B to CLKBA	0		0		
t _S (H)	Setup Time, A to LEAB	4.0		4.0		ns
t _S (L)	or B to LEBA, CLK HIGH	4.0		4.0		
t _H (H)	Hold Time, A to LEAB	1.5		1.5		ns
t _H (L)	or B to LEBA, CLK HIGH	1.5		1.5		
t _S (H)	Setup Time, A to LEAB	1.5		1.5		ns
t _s (L)	or B to LEBA, CLK LOW	1.5		1.5		
t _H (H)	Hold Time, A to LEAB	1.5		1.5		
t _H (L)	or B to LEBA, CLK LOW	1.5		1.5		ns
t _W (H)	Pulse Width,	3.3		3.3		ns
t _W (L)	LEAB or LEBA, HIGH	3.3		3.3		
t _W (H)	Pulse Width, CLKAB	3.3		3.3		ns
t _W (L)	or CLKBA, HIGH or LOW	3.3		3.3		

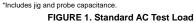
Capacitance

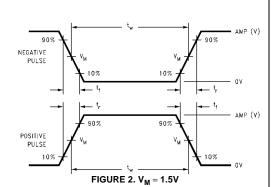
Symbol	Parameter	Тур	Units	Conditions T _A = 25°C
C _{IN}	Input Capacitance	5.0	pF	V _{CC} = 0.0V
C _{I/O} (Note 10)	Output Capacitance	11.0	pF	$V_{CC} = 5.0V$

Note 10: C_{I/O} is measured at frequency f = 1 MHz per MIL-STD-883, Method 3012.

AC Loading







Input Pulse Requirements

Amplitude	Rep. Rate	t _W	t _r	t _f
3.0V	1 MHz	500 ns	2.5 ns	2.5 ns

FIGURE 3. Test Input Signal Requirements

AC Waveforms

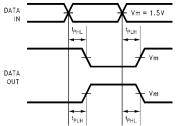


FIGURE 4. Propagation Delay Waveforms for Inverting and Non-Inverting Functions

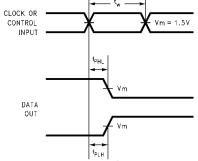


FIGURE 5. Propagation Delay, Pulse Width Waveforms

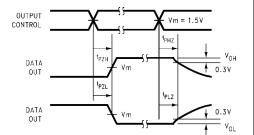
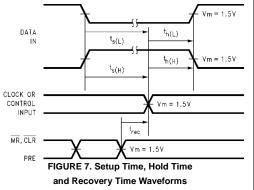
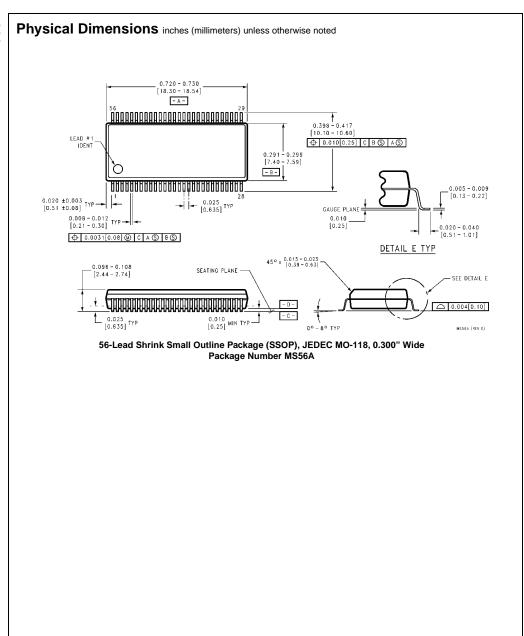
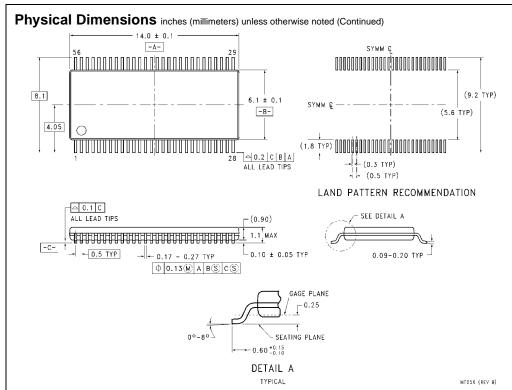


FIGURE 6. 3-STATE Output HIGH and LOW Enable and Disable Times



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56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD56

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